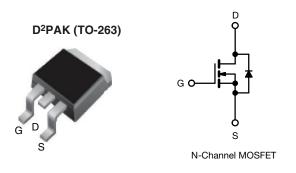


Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



| PRODUCT SUMMARY | | | | | | | |
|--|-----------------|-------|--|--|--|--|--|
| V _{DS} (V) at T _J max. | 650 | | | | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | $V_{GS} = 10 V$ | 0.088 | | | | | |
| Q _g max. (nC) | 53 | | | | | | |
| Q _{gs} (nC) | 12 | | | | | | |
| Q _{gd} (nC) | 11 | | | | | | |
| Configuration | Sin | gle | | | | | |

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

| ORDERING INFORMATION | | | | |
|---------------------------------|-----------------------------|--|--|--|
| Package | D ² PAK (TO-263) | | | |
| Lead (Pb)-free and halogen-free | SiHB105N60EF-GE3 | | | |

| PARAMETER | SYMBOL | LIMIT | UNIT | | |
|---|-----------------------------------|--|-----------------|------|------|
| Drain-source voltage | V _{DS} | 600 | v | | |
| Gate-source voltage | V _{GS} | ± 30 | v | | |
| Continuous drain current ($T_{,1} = 150 \ ^{\circ}C$) | V _{GS} at 10 V | $T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$ | ID | 29 | |
| Continuous drain current $(1) = 150^{\circ}$ C) | VGS AL TO V | | | 19 | А |
| Pulsed drain current ^a | I _{DM} | 73 | | | |
| Linear derating factor | | | 1.67 | W/°C | |
| Single pulse avalanche energy ^b | | | E _{AS} | 226 | mJ |
| Maximum power dissipation | | PD | 208 | W | |
| Operating junction and storage temperature range | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-source voltage slope | 5 °C | du /dt | 70 | V/no | |
| Reverse diode dv/dt ^d | • | | dv/dt | 50 | V/ns |
| Soldering recommendations (peak temperature) ^c | For 10 |)s | | 260 | °C |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D, \, di/dt = 400$ A/µs, starting $T_J = 25 \ ^\circ C$



COMPLIANT

HALOGEN

FREE



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | | | | |
|----------------------------------|-------------------|------|------|------|--|--|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | | | |
| Maximum junction-to-ambient | R _{thJA} | - | 62 | °C/W | | | | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 0.6 | C/W | | | | |

| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|--|------|-------|-------|------|
| Static | | | | | • | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 250 μΑ | 600 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.63 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | : V _{GS} , I _D = 250 μΑ | 3 | - | 5 | V |
| | | , | V _{GS} = ± 20 V | - | - | ± 100 | nA |
| Gate-source leakage | I _{GSS} | , | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μA |
| Zana and a sultance durin assument | I _{DSS} | V _{DS} = | $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | μA |
| Zero gate voltage drain current | | V _{DS} = 480 V | ′, V _{GS} = 0 V, T _J = 125 °C | - | - | 2 | mA |
| Drain-source on-state resistance | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 13 A | - | 0.088 | 0.102 | Ω |
| Forward transconductance ^a | 9 _{fs} | V _{DS} = 20 V, I _D = 13 A | | - | 8 | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | | V _{GS} = 0 V, | - | 1804 | - | |
| Output capacitance | C _{oss} |] , | $V_{\rm DS} = 100 \rm V,$ | - | 82 | - |] |
| Reverse transfer capacitance | C _{rss} | | f = 1 MHz | - | 6 | - | |
| Effective output capacitance, energy related ^a | C _{o(er)} | | $V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V | | 63 | - | pF |
| Effective output capacitance, time related ^b | C _{o(tr)} | $V_{\rm DS} = 0$ | | | 407 | - | |
| Total gate charge | Qg | | | - | 35 | 53 | |
| Gate-source charge | Q _{gs} | V _{GS} = 10 V | I _D = 11 A, V _{DS} = 480 V | - | 12 | - | nC |
| Gate-drain charge | Q _{gd} | | | - | 11 | - | |
| Turn-on delay time | t _{d(on)} | | | - | 20 | 40 | |
| Rise time | t _r | V _{DD} = | = 480 V, I _D = 13 A, | - | 28 | 56 | 1 |
| Turn-off delay time | t _{d(off)} | V _{GS} = | = 10 V, $R_g = 9.1 \Omega$ | - | 39 | 78 | ns |
| Fall time | t _f | | | - | 19 | 38 | |
| Gate input resistance | Rg | f = 1 | MHz, open drain | 0.3 | 0.7 | 1.4 | Ω |
| Drain-Source Body Diode Characteristic | s | - | | | | | |
| Continuous source-drain diode current | I _S | showing the | MOSFET symbol showing the integral reverse p - n junction diode | | - | 29 | |
| Pulsed diode forward current | I _{SM} | 0 | | | - | 73 | A |
| Diode forward voltage | V _{SD} | T _J = 25 °C | C, I _S = 13 A, V _{GS} = 0 V | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | | | - | 125 | 250 | ns |
| Reverse recovery charge | Q _{rr} | | 5 °C, I _F = I _S = 13 A, 00 A/µs, V _B = 400 V | - | 0.8 | 1.6 | μC |
| Reverse recovery current | I _{RRM} | | $00 \text{ Av} \mu \text{s}, \text{ v}_{\text{R}} = 400 \text{ v}$ | - | 12 | - | A |

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

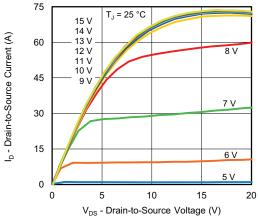


Fig. 1 - Typical Output Characteristics

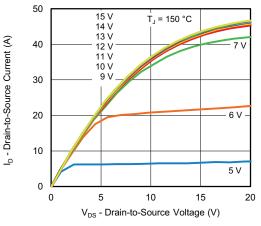


Fig. 2 - Typical Output Characteristics

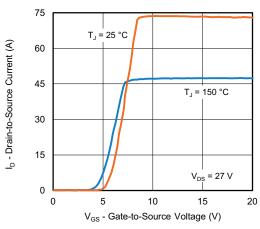


Fig. 3 - Typical Transfer Characteristics

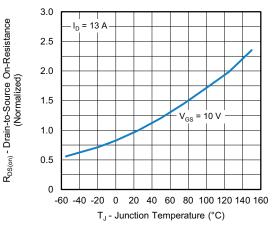


Fig. 4 - Normalized On-Resistance vs. Temperature

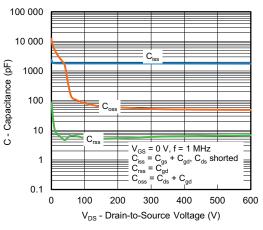
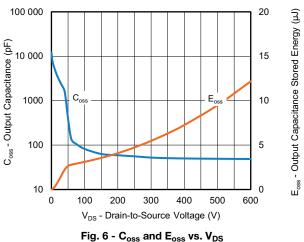


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S19-1042-Rev. A, 09-Dec-2019

3 For technical questions, contact: hvm@vishay.com Document Number: 92302

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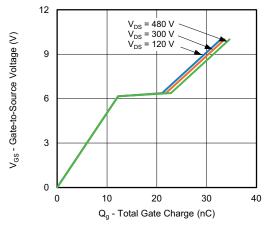


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

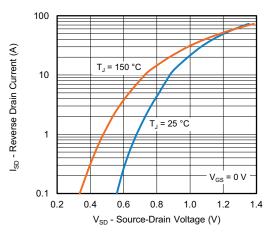


Fig. 8 - Typical Source-Drain Diode Forward Voltage

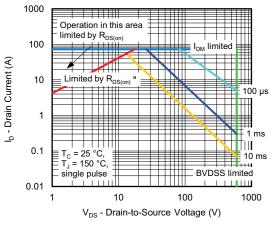


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

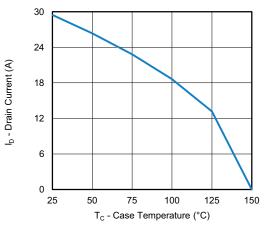


Fig. 10 - Maximum Drain Current vs. Case Temperature

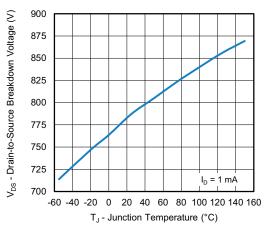


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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4

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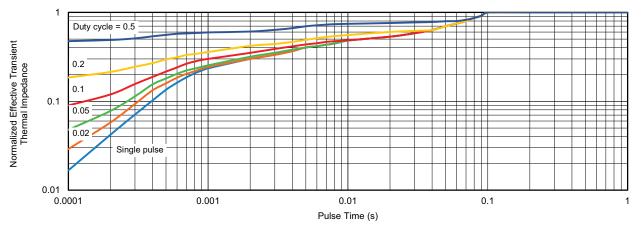


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

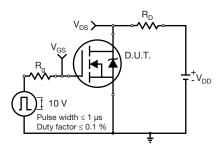


Fig. 13 - Switching Time Test Circuit

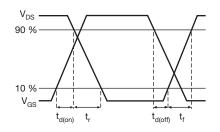


Fig. 14 - Switching Time Waveforms

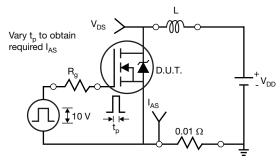


Fig. 15 - Unclamped Inductive Test Circuit

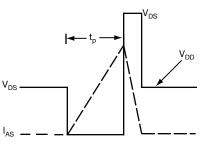


Fig. 16 - Unclamped Inductive Waveforms

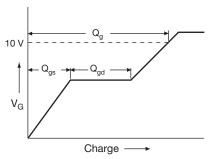


Fig. 17 - Basic Gate Charge Waveform

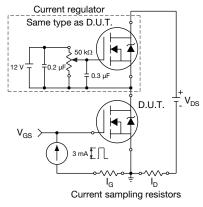
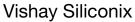


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

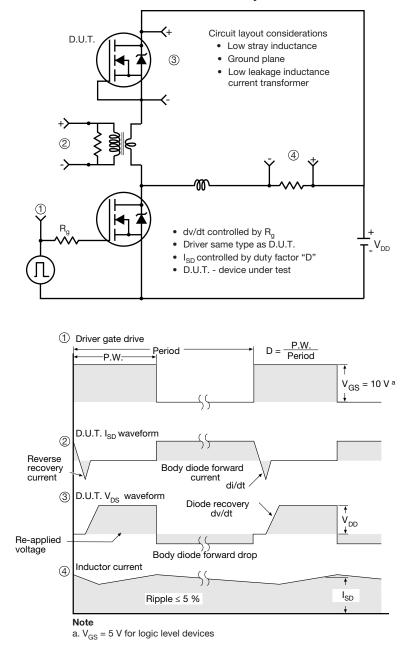


Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

| | 2 | - | Y 2 x b2 2 x b ⊕ 0.010 @ A(| ■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c) | $\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$ | a - 1 | | Ū. | 1 <u>4</u> | |
|--------------------------------|--|--|--|---|---|-------------------------------|---|---|--|--|
| | MILLIN | IETERS | INCHES | | | | MILLIMETERS | | INCHES | |
| DIM. | MIN. | MAX. | MIN. | MAX. | | DIM. | MIN. | MAX. | MIN. | MAX. |
| А | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | - | 0.270 | - |
| | | | | 0.010 | | - | | 10.07 | 0.000 | 0.420 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.120 |
| A1 b | 0.00 0.51 | 0.25 0.99 | 0.000 | 0.010 | | E1 | 9.65 6.22 | - 10.67 | 0.380 | - |
| | | | | | | | 6.22 | - 10.67 - BSC | 0.245 | - BSC |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 6.22 | - | 0.245 | - |
| b b1 | 0.51 0.51 | 0.99 0.89 | 0.020 0.020 | 0.039 0.035 | | E1 e | 6.22 2.54 | - BSC | 0.245 | -) BSC |
| b b1 b2 | 0.51 0.51 1.14 | 0.99 0.89 1.78 | 0.020 0.020 0.045 | 0.039 0.035 0.070 | | E1 e H | 6.22 2.54 14.61 | - BSC 15.88 | 0.245 0.100 0.575 | -) BSC 0.625 |
| b b1 b2 b3 | 0.51 0.51 1.14 1.14 | 0.99 0.89 1.78 1.73 | 0.020 0.020 0.045 0.045 | 0.039 0.035 0.070 0.068 | | E1 e H L | 6.22 2.54 14.61 1.78 | - BSC 15.88 2.79 | 0.245 0.100 0.575 0.070 | - 0 BSC 0.625 0.110 |
| b b1 b2 b3 c | 0.51 0.51 1.14 1.14 0.38 | 0.99 0.89 1.78 1.73 0.74 | 0.020 0.020 0.045 0.045 0.015 | 0.039 0.035 0.070 0.068 0.029 | | E1 e H L L1 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 |
| b b1 b2 b3 c c1 | 0.51 0.51 1.14 1.14 0.38 0.38 | 0.99 0.89 1.78 1.73 0.74 0.58 | 0.020 0.020 0.045 0.045 0.015 0.015 | 0.039 0.035 0.070 0.068 0.029 0.023 | | E1 e H L L1 L2 | 6.22 2.54 14.61 1.78 - - | - BSC 15.88 2.79 1.65 1.78 | 0.245 0.100 0.575 0.070 - - | - 0 BSC 0.625 0.110 0.066 0.070 |

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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1



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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1